SDLS006

D2634, JANUARY 1981 REVISED MARCH 1988

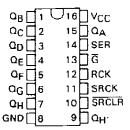
- 8-Bit Serial-In, Parallel-Out Shift Registers with Storage
- Choice of 3-State ('LS595) or Open-Collector ('LS596) Parallel Outputs
- Shift Register Has Direct Clear
- Accurate Shift Frequency: DC to 20 MHz

description

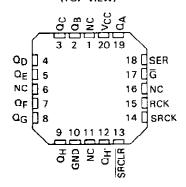
These devices each contain an 8-bit serial-in, parallel-out shift register that feeds an 8-bit D-type storage register. The storage register has parallel 3-state ('LS595) or open-collector ('LS596) outputs. Separate clocks are provided for both the shift register and the storage register. The shift register has a direct-overriding clear, serial input, and serial output pins for cascading.

Both the shift register and storage register clocks are positive-edge triggered. If the user wishes to connect both clocks together, the shift register state will always be one clock pulse ahead of the storage register.

SN54LS595, SN54LS596...J OR W PACKAGE SN74LS595, SN74LS596...N PACKAGE (TOP VIEW)

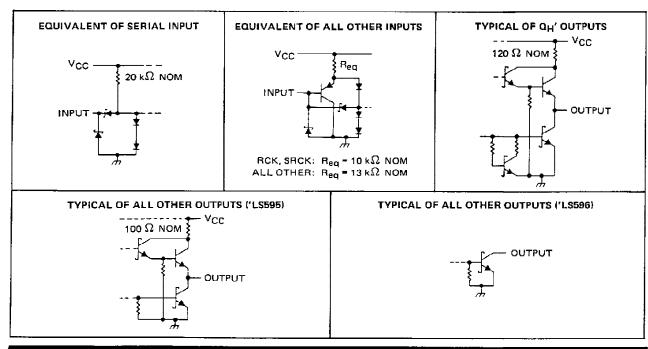


SN54LS595, SN54LS596 . . . FK PACKAGE (TOP VIEW)



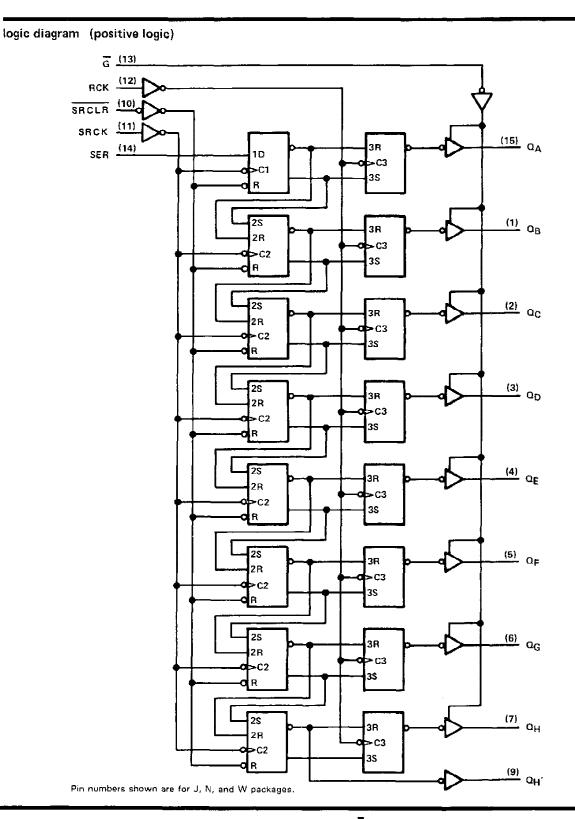
NC - No internal connection

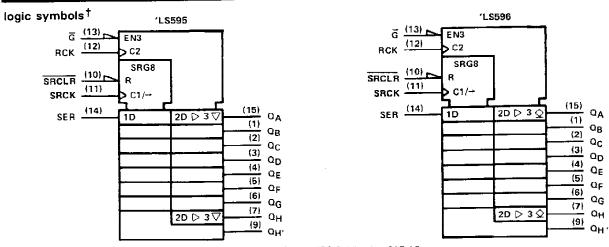
schematics of inputs and outputs



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 $^{^{\}dagger}$ These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12. Pin numbers shown are for J, N, and W packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, Vcc (see Note 1)		
Input voltage		
Offictate output voltage		5.5 V
Operation free-air temperature range:	: SN54LS595.SN54LS596	55 C to 125 C
	SN741 S595, SN74LS596	0°C to /0°C
Storage temperature range		– 65°C to 150°C

NOTE 1: Voltage values are with respect to the network ground terminal.

recommended operating conditions

				SN54LS	3'		SN74LS	s'	UNIT	
			MIN	NOM	MAX	MIN	NOM	MAX	UNI	
V _{CC}	Supply voltage		4.5	5	5.5	4.75	5	5.25		
ViH	High-level input voltage		2			2			V	
VIL	Low-level input voltage				0.7			0.8	V	
VOH	High-level output voltage	QA thru QH, 'LS596 only			5.5			5.5	٧	
		QH,			-1			- 1	mA	
10H	High-level output current	Q _A thru Q _H , 'L\$595 only			- 1			- 2.6		
¹ OL	Low-level output current	OH'			8			16	mA	
		Q		_	12			24		
fSRCK	Shift clock frequency	1	0		20	0		20	МН	
tw(SRCK)	Duration of shift clock pulse		25			25			ns	
tw(RCK)	Duration of register clock pul	SE	20			20			ns	
tw(SRCLR)	Duration of shift clear pulse,	low level	20			20			ns	
77,0110 = 111		SRCLR inactive before SRCK 1	20			20			<u> </u>	
		SER before SRCK t	20			20			ns	
t _{Sti}	Setup time	SRCK † before RCK † (see Note 2)	40			40]	
		SRCLR low before RCK t	40			40				
th	Hold time	SER after SRCK †	0			0			ns	
TA	Operating free-air temperatur	e	- 55		125	0		70	°C	

NOTE 2: This setup time ensures the register will see stable data from the shift-register outputs. The clocks may be connected together, in which case the storage register state will be one clock pulse behind the shift register.



SN54LS595, SN54LS596, SN74LS595, SN74LS596 8-BIT SHIFT REGISTERS WITH OUTPUT LATCHES

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS †			SN54LS	;;	SN74LS'			UNIT	
FARA	TAICIEN	I EST CONL	THOMS '	MIN	TYP#	MAX	MIN	TYP\$	MAX	OIGIT	
Vik		V _{CC} = MIN, I ₁ = - 18 mA				- 1.5			– 1.5	V	
	'LS595 Q	V _{CC} = MIN, V _{IH} = 2 V,	lOH = - 1 mA	2.4	3.2						
∨он		V)[= MAX	I _{OH} 2.6 mA	-		-	2.4	3.1		٧	
·	QH'		1 _{OH} = -1 mA	2.4	3.2		2.4	3.2			
IОН	'L\$596 Q	$V_{CC} = MIN, V_{IH} = 2 V, V_{I}$	L = MAX, V _{OH} = 5.5 V			0.1			0.1	mΑ	
Q	0		I _{OL} = 12 mA		0.25	0.4		0.25	0.4		
VOL		V _{CC} = MIN, V _{IH} = 2 V,	I _{OL} = 24 mA					0.35	0.5	0.5 V	
*U£	σ _H ′	VIL = MAX	10L = 8 mA		0.25	0.4		0,25	0.4	•	
			I _{QL} ≈ 16 mA					0.35	0,5		
lozh	'LS595 Q	VCC = MAX, VIH = 2 V, VI	L = MAX, V _{OH} = 2.7 V			20			20	μA	
IOZL	'LS595 Q	VCC = MAX, VIH = 2 V, VI	L = MAX, VOH = 0.4 V			- 20			- 20	μА	
l ₁		VCC = MAX, VI = 7 V				0.1			0.1	mA	
ЧН		V _{CC} - MAX, V ₁ = 2.7 V				20			20	μА	
1	SER	Vcc = MAX, V1 = 0.4 V				- 0.4			- 0.4	mΑ	
1 L	All others	VCC MAX, V) "GA V				- 0.2			- 0.2	i ma	
les X	'LS595 Q	V _{CC} = MAX, V _C = 0 V		- 30		130	- 30		- 130	^	
los §	Q _H ′	VCC - WAX, VO - 0 V		- 20		- 100	- 20		- 100		
lance	'LS595	-			33	50		33	50	mΑ	
ICCH	'LS596	V _{CC} = MAX,			30	45		30	45	mA	
loo	'LS595	All possible inputs grounded,		_	42	65		42	65		
CCL	CCL /LS596 All outputs open				36	55		36	55	mA	
¹ccz	'L S 595				44	65		44	65	mΑ	

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions,

[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.
§ Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

SN54LS595, SN54LS596, SN74LS595, SN74LS596 8-BIT SHIFT REGISTERS WITH OUTPUT LATCHES

switching characteristics, VCC = 5 V, TA = 25° C (see note 3)

DADAMETER	FROM	то	TEST ODA	DITIONS		'LS595	;	'LS596			UNIT
PARAMETER	(INPUT)	(OUTPUT)	TEST CON	MIN	TYP	MAX	MIN	TYP	MAX	UNII	
tPLH	SRCK1		5 46	C _L = 30 pF		12	18		14	21	ns
^t PHL	SHUKT	ΦH'	R _L = 1kΩ,			17	25		20	30	ns
^t PLH	RCK 1	Q _A thru Q _H	R _L = 667 Ω,	C _L = 45 pF	1	12	18		28	42	ns
^t PHL	, nck '	da iiiu da				24	35		24	35	ns
tPZH	Ğ↓	QA thru QH				20	30				ns
tPZL	1 3 .					25	38				ns
^t PHZ	<u>G</u> ↑	Q _A thru Q _H	$R_1 = 667 \Omega$.	C _L = 5 pF		20	30				ns
tPLZ	1 3 '	QA INTO CH	UL - 601 71,			25	38				ns
tPLH .	Ğ١	Qд thru Qн	$R_1 = 667 \Omega_s$	C. = 45 oF			·		40	60	ns
tPHL	Ğ∔	Q _A thru Q _H	WE - 00 / 12,	C _L = 45 pF					25	38	ns
^t PHL	SRCLR +	QH'	$R_{L} = 1 k\Omega$,	CL = 30 pF		24	35		24	35	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
5962-8671701EA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8671701EA SNJ54LS595J	Samples
5962-8671701FA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8671701FA SNJ54LS595W	Samples
5962-8671701FA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8671701FA SNJ54LS595W	Samples
SN54LS595J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS595J	Samples
SN54LS595J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS595J	Samples
SN74LS595D	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS595	Samples
SN74LS595D	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS595	Samples
SN74LS595DG4	ACTIVE	SOIC	D	16	40	TBD	Call TI	Call TI	0 to 70		Samples
SN74LS595DG4	ACTIVE	SOIC	D	16	40	TBD	Call TI	Call TI	0 to 70		Samples
SN74LS595DR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS595	Samples
SN74LS595DR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS595	Samples
SN74LS595N	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS595N	Samples
SN74LS595N	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS595N	Samples
SNJ54LS595J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8671701EA SNJ54LS595J	Samples
SNJ54LS595J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8671701EA SNJ54LS595J	Samples
SNJ54LS595W	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8671701FA SNJ54LS595W	Samples
SNJ54LS595W	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8671701FA SNJ54LS595W	Samples

⁽¹⁾ The marketing status values are defined as follows:

PACKAGE OPTION ADDENDUM

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ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF SN54LS595, SN74LS595:

Catalog: SN74LS595

Military: SN54LS595

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product

Addendum-Page 2

PACKAGE OPTION ADDENDUM

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• Military - QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

	Device		Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	` '	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
ı	SN74LS595DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1

PACKAGE MATERIALS INFORMATION

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*All dimensions are nominal

	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
ı	SN74LS595DR	SOIC	D	16	2500	340.5	336.1	32.0	

PACKAGE MATERIALS INFORMATION

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TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
5962-8671701FA	W	CFP	16	1	506.98	26.16	6220	NA
SN74LS595D	D	SOIC	16	40	507	8	3940	4.32
SN74LS595N	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS595N	N	PDIP	16	25	506	13.97	11230	4.32
SNJ54LS595W	W	CFP	16	1	506.98	26.16	6220	NA

D (R-PDS0-G16)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP2-F16



14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

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